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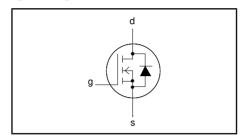


## PHK4NQ10T

### **FEATURES**

- Low on-state resistance
- Fast switching
- Low profile surface mount package

### **SYMBOL**



### **QUICK REFERENCE DATA**

$$V_{DS} = 100 \text{ V}$$
 
$$I_D = 4 \text{ A}$$
 
$$R_{DS(ON)} \le 70 \text{ m}\Omega \text{ (V}_{GS} = 10 \text{ V)}$$

### **GENERAL DESCRIPTION**

N-channel enhancement mode field-effect transistor in a plastic envelope using 'trench' technology.

#### Applications:-

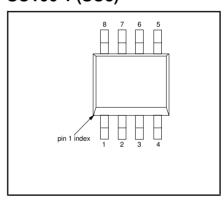
- Motor and relay drivers
- d.c. to d.c. converters

The PHK4NQ10T is supplied in the SOT96-1 (SO8) surface mounting package.

### **PINNING**

| PIN | DESCRIPTION |  |
|-----|-------------|--|
| 1-3 | source      |  |
| 4   | gate        |  |
| 5-8 | drain       |  |
|     |             |  |
|     |             |  |
|     |             |  |

## SOT96-1 (SO8)



### **LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL           | PARAMETER                                  | CONDITIONS  | MIN. | MAX. | UNIT |
|------------------|--|---|------|------|------|
| $V_{DSS}$        | Drain-source voltage                       | T <sub>i</sub> = 25 °C to 150°C                       | -    | 100  | V    |
| $V_{DGR}$        | Drain-gate voltage                         | T <sub>i</sub> = 25 °C to 150°C;                      | -    | 100  | V    |
|                  |  | $R_{GS} = 20 \text{ k}\Omega$                         |      |      |      |
| $V_{GS}$         | Gate-source voltage                        |   | -    | ± 20 | V    |
| I <sub>D</sub>   | Drain current $(t_p \le 10 \text{ s})$     | $T_a = 25 ^{\circ}C$                                  | -    | 4    | Α    |
|                  | · · ·                                      | $T_a = 70  ^{\circ}C$                                 | -    | 3    | Α    |
| I <sub>DM</sub>  | Drain current (pulse peak value)           | $T_a = 25 ^{\circ}C$                                  | -    | 16   | Α    |
| P <sub>tot</sub> | Total power dissipation                    | $T_a = 25 {}^{\circ}\text{C}, t \le 10 {}_{\text{S}}$ | -    | 2.5  | W    |
|                  |  | $T_a = 70  ^{\circ}\text{C},  t \le 10  \text{s}$     | -    | 1.6  | W    |
| $T_{j},T_{stg}$  | Operating junction and storage temperature |   | - 65 | 150  | °C   |

### THERMAL RESISTANCES

| SYMBOL              | PARAMETER                               | CONDITIONS                             | TYP. | MAX. | UNIT |
|---------------------|---|--|------|------|------|
| R <sub>th j-a</sub> | Thermal resistance junction to ambient  | Surface mounted, FR4 board, t ≤ 10 sec | -    | 50   | K/W  |
| R <sub>th j-a</sub> | 100 00000000000000000000000000000000000 | Surface mounted, FR4 board             | 150  | -    | K/W  |

PHK4NQ10T

### **ELECTRICAL CHARACTERISTICS**

T<sub>i</sub>= 25°C unless otherwise specified

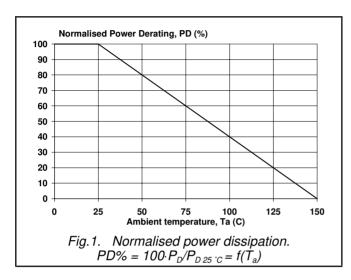
| SYMBOL              | PARAMETER                   | CONDITIONS  | MIN.    | TYP.   | MAX.   | UNIT |
|---------------------|-----------------------------|---|---------|--------|--------|------|
| $V_{(BR)DSS}$       | Drain-source breakdown      | $V_{GS} = 0 \text{ V}; I_D = 10 \mu\text{A};$                     | 100     | -      | -      | V    |
| W                   | voltage                     | $V_{DS} = V_{GS}$ ; $I_{D} = 1 \text{ mA}$                        | 89<br>2 | 3      | -<br>4 | V    |
| $V_{GS(TO)}$        | Gate threshold voltage      |   | 1.1     | -<br>- | 4      | V I  |
|                     |                             | T <sub>j</sub> = 150°C<br>T <sub>i</sub> = -55°C                  |         |        | 6      | ν̈Ι  |
| R <sub>DS(ON)</sub> | Drain-source on-state       | $V_{GS} = 10 \text{ V}; I_D = 4 \text{ A}$                        | -       | 65     | 70     | mΩ   |
| 23(314)             | resistance                  | $T_i = 150^{\circ}C$  | -       | -      | 168    | mΩ   |
| I <sub>GSS</sub>    | Gate source leakage current | $V_{GS} = \pm 20 \text{ V}; V_{DS} = 0 \text{ V}$                 | -       | 10     | 100    | nA   |
| I <sub>DSS</sub>    | Zero gate voltage drain     | $V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V};$                   | -       | 0.05   | 10     | μΑ   |
|                     | current                     | $T_j = 150^{\circ}C$  | -       | 5      | 100    | μΑ   |
| $Q_{g(tot)}$        | Total gate charge           | $I_D = 4 \text{ A}; V_{DD} = 80 \text{ V}; V_{GS} = 10 \text{ V}$ | -       | 22     | -      | nC   |
| $Q_{gs}$            | Gate-source charge          |   | -       | 4      | -      | nC   |
| $Q_{gd}$            | Gate-drain (Miller) charge  |   | -       | 8      | -      | nC   |
| t <sub>d on</sub>   | Turn-on delay time          | $V_{DD} = 50 \text{ V}; R_D = 12 \Omega;$                         | -       | 6      | -      | ns   |
| t <sub>r</sub>      | Turn-on rise time           | $V_{GS} = 10 \text{ V}; R_{G} = 5.6 \Omega$                       | -       | 13     | -      | ns   |
| t <sub>d off</sub>  | Turn-off delay time         | Resistive load  | -       | 26     | -      | ns   |
| t <sub>f</sub>      | Turn-off fall time          |   | -       | 12     | -      | ns   |
| L <sub>d</sub>      | Internal drain inductance   | Measured from drain lead to centre of die                         | -       | 1      | -      | nΗ   |
| L <sub>s</sub>      | Internal source inductance  | Measured from source lead to source                               | -       | 3      | -      | nH   |
|                     |                             | bond pad  |         |        |        |      |
| C <sub>iss</sub>    | Input capacitance           | $V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$  | -       | 880    | -      | рF   |
| Coss                | Output capacitance          |   | -       | 137    | -      | pF   |
| $C_{rss}$           | Feedback capacitance        |   | -       | 84     | -      | pF   |

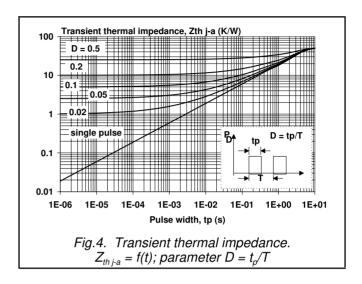
### **REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS**

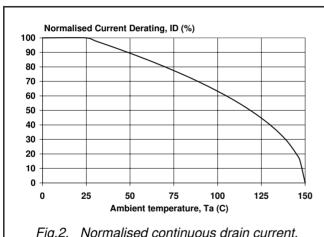
 $T_j = 25^{\circ}C$  unless otherwise specified

| SYMBOL                             | PARAMETER  | CONDITIONS   | MIN. | TYP.      | MAX. | UNIT     |
|------------------------------------|--|--|------|-----------|------|----------|
| I <sub>s</sub>                     | Continuous source current (body diode)           | $T_a = 25  ^{\circ}C, t_p \le 10  s$   | -    | -         | 2.3  | Α        |
| I <sub>SM</sub>                    | Pulsed source current (body diode)               |  | -    | -         | 15   | Α        |
| $V_{SD}$                           | Diode forward voltage                            | $I_F = 4 \text{ A}; V_{GS} = 0 \text{ V}$  | -    | 0.82      | 1.2  | ٧        |
| t <sub>rr</sub><br>Q <sub>rr</sub> | Reverse recovery time<br>Reverse recovery charge | $I_F = 4 \text{ A}; -dI_F/dt = 100 \text{ A}/\mu\text{s};$<br>$V_{GS} = 0 \text{ V}; V_R = 25 \text{ V}$ | -    | 60<br>120 | -    | ns<br>nC |

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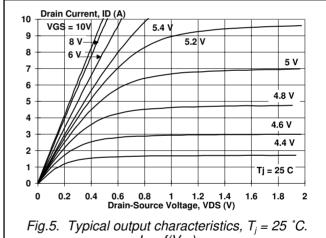
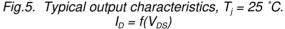
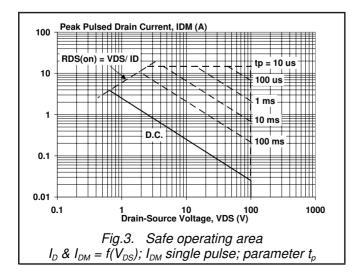
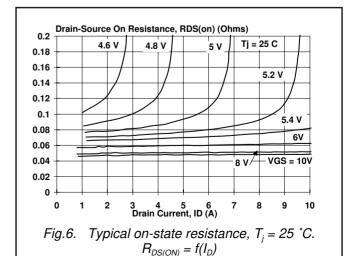


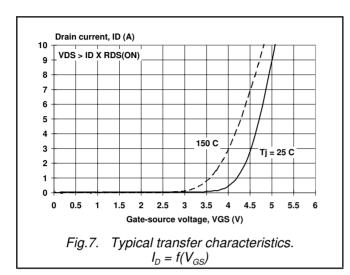
Fig.2. Normalised continuous drain current.  $ID\% = 100 \cdot I_D/I_{D.25 \cdot C} = f(T_a); V_{GS} \ge 10 \text{ V}$ 

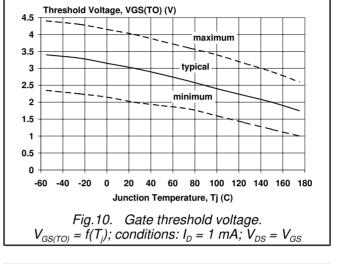


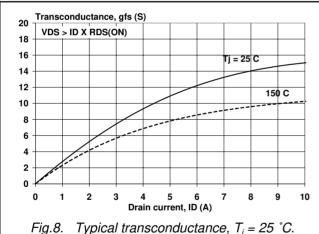


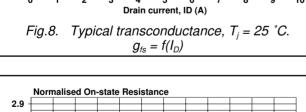


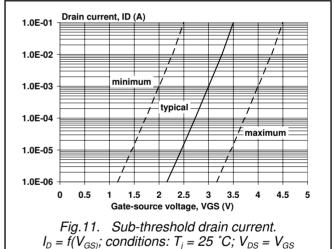
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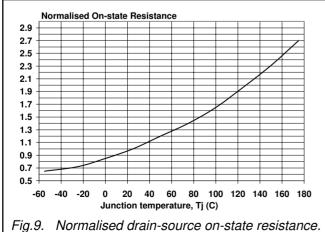




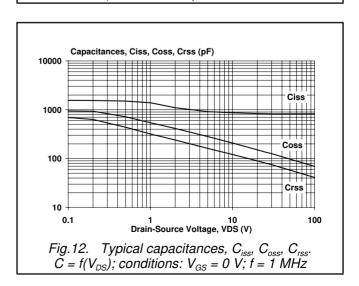




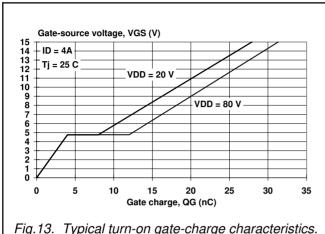


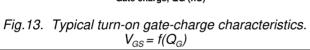


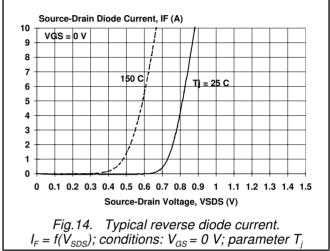
 $R_{DS(ON)}/R_{DS(ON)25} \cdot C = f(T_i)$ 



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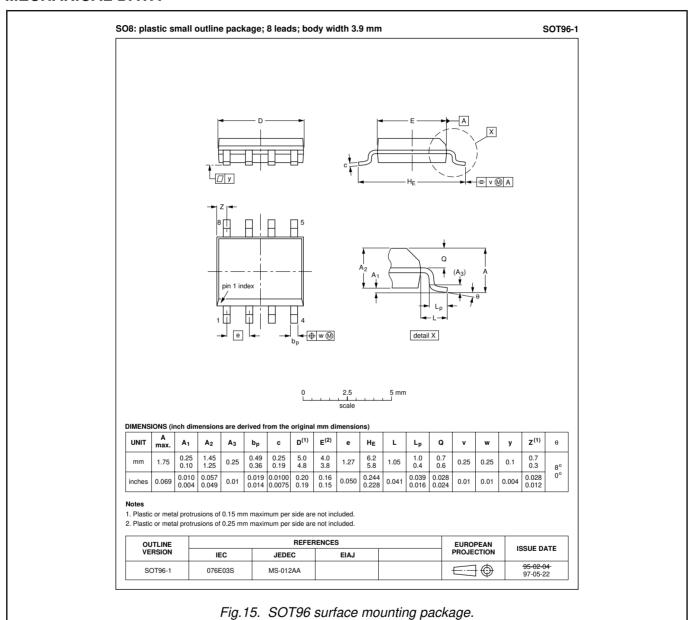






PHK4NQ10T

### **MECHANICAL DATA**



#### **Notes**

- 1. This product is supplied in anti-static packaging. The gate-source input must be protected against static discharge during transport or handling.
- 2. Refer to Integrated Circuit Packages, Data Handbook IC26.
- 3. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

## N-channel TrenchMOS<sup>™</sup> transistor

PHK4NQ10T

#### **DEFINITIONS**

| Data sheet status   |  |  |  |  |
|---|--|--|--|--|
| Objective specification This data sheet contains target or goal specifications for product development.       |  |  |  |  |
| Preliminary specification This data sheet contains preliminary data; supplementary data may be published late |  |  |  |  |
| Product specification This data sheet contains final product specifications.                                  |  |  |  |  |
| Limiting values   |  |  |  |  |

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

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